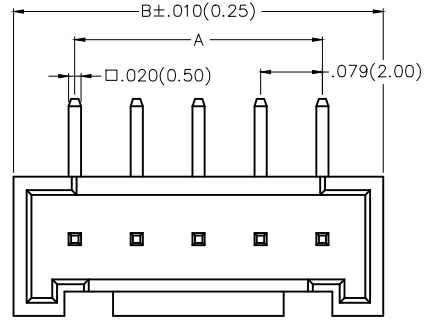
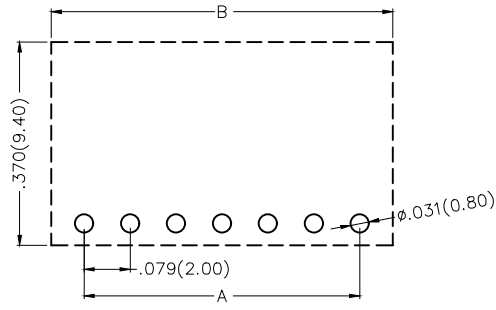
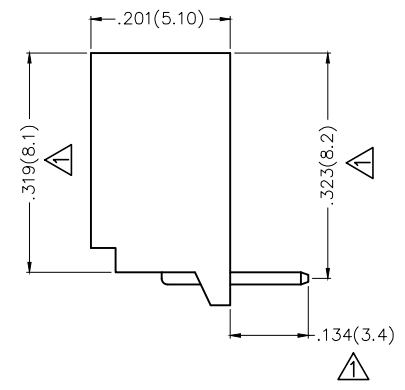
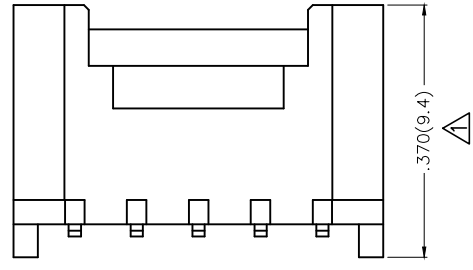


REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
1	△	Dimension: Change 9.25 into 9.4mm, Change 7.80 into 8.1mm, Change 7.95 into 8.2mm, Change 3.20 into 3.4mm.	17/OCT/18	KATE	FRANK



Electrical  
 Current Rating: 2.0A AC(rms)/DC  
 Voltage Rating: 125V AC(rms)/DC  
 Contact Resistance: 20 mΩ Max  
 Insulation Resistance: 1000 MΩ MIN  
 Withstanding Voltage: 1000V AC r.m.s  
 Temperature Range—Operating: -25°C~+85°C

Material and Plating  
 Housing: PA66( UL 94V-2)  
 Contact Pin: Brass  
 Plating: Tin Plated



Recommended P.C.Board Layout

Ordering Information

FWF 200 10 — S XX B 2 2 W1 B  
 1 2 3 4 5 6 7 8 9 10

1   Category FWF-Wafer	2   Series Number 200-Pitch2.0mm	3   Distinction No. 10	4   Row Option Single Row	5   Circuits XX	6   Entry Angle B-90° Angle
7   Plating 2-Tin Plated	8   Material-Resin 2-PA66	9   Color-Resin W1-White	10   Packaging B-PE Bag		

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 18/JUN/13	PART NO. FWF20010-SXXB22W1B	ITEM NO. FWF20010	 Leader Of Industry	
	DESIGN UNITS Inch (metric)	X.±.012(0.30)	.X'±5'	CHECKED BY JACOB	DATE 18/JUN/13	TITLE Wire to Board (Wafer) Pitch 2.0mm 90° Angled (DIP)		REV 1
SCALE 5:1	SIZE A4	X.XX±.008(0.20)	.X'±2'	DRAWN BY CHERRY	DATE 18/JUN/13	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

A

A

B

B

C

C

D

D



E

E

F

F

Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF20010-S02B22W1B	.079(2.00)	.236(6.00)
3	FWF20010-S03B22W1B	.157(4.00)	.315(8.00)
4	FWF20010-S04B22W1B	.236(6.00)	.394(10.00)
5	FWF20010-S05B22W1B	.315(8.00)	.472(12.00)
6	FWF20010-S06B22W1B	.394(10.00)	.551(14.00)
7	FWF20010-S07B22W1B	.472(12.00)	.630(16.00)
8	FWF20010-S08B22W1B	.551(14.00)	.709(18.00)
9	FWF20010-S09B22W1B	.630(16.00)	.787(20.00)
10	FWF20010-S10B22W1B	.709(18.00)	.866(22.00)
11	FWF20010-S11B22W1B	.787(20.00)	.945(24.00)
12	FWF20010-S12B22W1B	.866(22.00)	1.024(26.00)

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 18/JUN/13	PART NO. FWF20010-SXXB22W1B	ITEM NO. FWF20010	 Leader Of Industry	
	DESIGN UNITS Inch (metric)	X.±.012(0.30) X.X±.008(0.20) X.XX±.006(0.15) X.XXX±.004(0.10)	X.'±5' .X'±2' .XX'±1' .XXX'±0.5'	CHECKED BY JACOB	DATE 18/JUN/13	TITLE Wire to Board (Wafer) Pitch 2.0mm 90° Angled (DIP)		REV 1
	SCALE 5:1	SIZE A4	DRAWN BY CHERRY	DATE 18/JUN/13	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

1 2 3 4 5 6 7 8